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# Optimization on silicon detectors at CEPC

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# Outline

- Introduction
- Fast simulation and full simulation results
- Flavor tagging performance with different vertex geometry
- Influence of the material budget near beam pipe
  Performance of an ultra lightweight vertex layout
- Influence of SET on track and Higgs mass reconstruction
   Vertex detector prototype

# Introduction

- H -> bb, cc and gg is the core part of the CEPC Higgs program
- Vertex system with high impact parameter resolution is crucial

 Table 6.1
 Required performance of the CEPC sub-detectors for critical benchmark Higgs processes.

Physics Process	Measured Quantity	Critical Detector	Required Performance
$ZH \to \ell^+ \ell^- X$	Higgs mass, cross section	Tracker	$\Delta(1/p_{\rm T}) \sim 2 \times 10^{-5}$
$H \to \mu^+ \mu^-$	$BR(H \to \mu^+ \mu^-)$	Паскег	$\oplus 1  imes 10^{-3}/(p_{\mathrm{T}}\sin\theta)$
$H\to b\bar{b},\;c\bar{c},\;gg$	${\rm BR}(H\to b\bar{b},\ c\bar{c},\ gg)$	Vertex	$\sigma_{r\phi} \sim 5 \oplus 10/(p \sin^{3/2} \theta)  \mu \mathrm{m}$
$H\to q\bar{q}, \; VV$	${\rm BR}(H \to q \bar{q}, VV)$	ECAL, HCAL	$\sigma_E^{ m jet}/E\sim 3-4\%$
$H\to\gamma\gamma$	${\rm BR}(H\to\gamma\gamma)$	ECAL	$\sigma_E \sim 16\%/\sqrt{E} \oplus 1\%~({\rm GeV})$



 Table 1. Design parameters of the CEPC vertex system.

	R(mm)	Z  (mm)	$\sigma(\mu m)$	material budget
Layer 1	16	62.5	2.8	0.15%/X <sub>0</sub>
Layer 2	18	62.5	6	0.15%/X <sub>0</sub>
Layer 3	37	125.0	4	0.15%/X <sub>0</sub>
Layer 4	39	125.0	4	0.15%/X <sub>0</sub>
Layer 5	58	125.0	4	0.15%/X <sub>0</sub>
Layer 6	60	125.0	4	0.15%/X <sub>0</sub>

# Simulation tools

- Fast simulation: "LiC Detector Toy" (LDT) software tool
- Full simulation: Mokka and Marlin



consistent

## Key geometry parameters

• The influence of the geometry parameters on the impact parameter resolution

□ Inner radius, Material budget, Spatial resolution



# Flavor tagging performance

- Only di-jet final modes (bb, cc, gg) are considered, evaluated by ROC
- Case C: upgraded ALICE ITS; Case A: half values of the baseline design



C-tagging efficiency

C-tagging efficiency

	Scenario A (Aggressive)	Scenario B (Baseline)	Scenario C (Conservative)
Material per layer/ $X_0$	0.075	0.15	0.3
Spatial resolution/µm	1.4 - 3	2.8 - 6	5 - 10.7
R <sub>in</sub> /mm	8	16	23
			6

# Br(H->bb, cc) measurement

- Br (H -> cc) is extremely sensitive to the vertex design
- Br (H -> bb) is less sensitive to the vertex design

$$\frac{\delta_{\mu}}{\mu} \propto \frac{\sqrt{S+B}}{S} = \sqrt{\frac{1}{S}} \sqrt{\frac{S+B}{S}} \propto \frac{1}{\sqrt{\epsilon \cdot p}}.$$

**Table 3.** Maximum  $\epsilon \cdot p$  value comparison for the  $Br(H \to c\bar{c})$  measurement.

	Scenario A	Scenario B	Scenario C
$\epsilon \cdot p$	$0.133 \pm 0.002$	$0.095 \pm 0.001$	$0.078 \pm 0.001$
	41%		-22%

**Table 4.** Maximum  $\epsilon \cdot p$  value comparison for the  $Br(H \rightarrow b\bar{b})$  measurement.

	Scenario A	Scenario B	Scenario C
$\epsilon \cdot p$	$0.925 \pm 0.001$	$0.914 \pm 0.001$	$0.900 \pm 0.001$
	1%		-1.5%



Inner radius is the most sensitive parameter

## Material budget near beam pipe

- BESIII beam pipe material: 1.04%/X<sub>0</sub> (Be: 0.4%, gold: 0.44%, SMO: 0.2%)
- CEPC beam pipe material: 0.14%/X<sub>0</sub> Be, heat load more than 1000 W
- Have to increase the material budget near beam pipe due to cooling Beam pipe support



### Material budget near beam pipe

- Have to increase the material budget near beam pipe due to cooling system
- Influence is comparable with the material change of vertex detector



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#### An ultra lightweight vertex layout

- ALICE ITS3: a cylindrical layer of silicon-only sensors, stitching and thinning
- The geometry is similar with CEPC baseline design



#### An ultra lightweight vertex layout

- new layout 1: 6 layers r(mm)=16,24,32,40,50,60; single point resolution 4µm/layer; 0.05%X<sub>0</sub>/layer; B=3T
- new layout 2: 6 layers r(mm)=16,24,32,40,50,60; single point resolution 2.8µm/innermost layer, 4µm/outside layers; 0.05%X<sub>0</sub>/layer; B=3T



2D-schematic

3D-schematic

#### Performance of an ultra lightweight vertex layout

- For impact parameter resolution, better performance (~20% improvement) for layout1 at low momentum, but poor performance at high momentum
- The performance of layout2 is better than baseline design
- Full simulation study is undergoing



Material budget plays a major role at low momentum, while resolution plays a major role at high momentum.

# SET introduction

- Silicon External Tracker, providing precise hit points after the TPC
- Improving the overall tracking performance in the central region
- Extrapolating from the TPC to the calorimeter



#### Effect of SET on track reconstruction

SET has a high influence on the resolution of ZO, theta and omega
 When Pt is high
 Made b



#### Effect of SET on Higgs Mass reconstruction

- Higgs mass resolution in H-> $\mu^+\mu^-$ . Use MC information to find out true  $\mu$  tracks
- High influence on Higgs Mass resolution

Made by Taifan.



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# Vertex detector prototype

by Jinyu

- Plan to build a vertex detector prototype in 2~3 years
  - Supported by Ministry of Science and Technology (MOST)
  - With full-size support structure
  - Part of modules will be installed to test spatial resolution of vertex detector

**Collaboration with Livepool and Oxford on detector structure design** 



#### **Engineering design of vertex detector**



# Thanks for your attention!

